

PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

**REVOCATION AND NEW POWER OF ATTORNEY AND
CHANGE OF CORRESPONDENCE ADDRESS**

I, *Dr. Graham Fisher, Director of Intellectual Property of MEMC Electronic Materials, Inc.*, the Assignee of the entire right, title, and interest in the *U.S. Patent Application(s) and/or Patent(s) identified on the attached Schedule A*, hereby revoke all previous powers of attorney or authorizations of agent given and do hereby appoint the attorneys or agents associated with the following Customer Number, with full power of substitution and revocation, to prosecute and transact all business in the Patent and Trademark Office connected therewith for the *U.S. Patent Application(s) and/or Patent(s) listed in the attached Schedule A*:

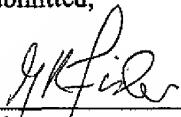
Customer Number: 76681

Please direct all correspondence in connection with said *U.S. Patent Application(s) and/or Patent(s)* to:

Customer Number: 76681

Respectfully submitted,

Date: 5/13/2008


Dr. Graham Fisher
Director of Intellectual Property
MEMC Electronic Materials, Inc.

PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

STATEMENT UNDER 37 CFR 3.73(b)

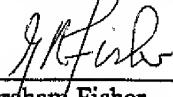
MEMC Electronic Materials, Inc., a Delaware Corporation, pursuant to 37 CFR 3.73(b), hereby states that it is the Assignee of the entire right, title, and interest in *U.S. Patent Application(s) and/or Patent(s) on the attached Schedule A*.

The entire rights, title, and interest in the aforementioned Patent Application(s) and/or Patent(s) were conveyed to *MEMC Electronic Materials, Inc.* via Assignment(s) recorded with the United States Patent and Trademark Office at the *Reel/Frame Numbers on the attached Schedule A*.

The undersigned, *Dr. Graham Fisher, Director of Intellectual Property*, has full authorization to act on behalf of Assignee *MEMC Electronic Materials, Inc.*

Respectfully submitted,

Date: 5/13/2008



Dr. Graham Fisher
Director of Intellectual Property
MEMC Electronic Materials, Inc.

APPENDIX A
Owned by MEMC Electronic Materials, Inc.

ATTORNEY REFERENCE	CONF. NO	PUBLICATION NO. & DATE	SERIAL NO. & FILING DATE	PATENT NO. ISSUE DATE	CURRENT OWNER/ ASSIGNEE	REEL AND FRAME NO.	TITLE
2844-215 (MEMC2905.16)	4312	US2007-0169683-A1 7/26/2007	11623-142 1/15/2007	10380,806 7/30/2003	MEMC Electronic Materials, Inc.	Division of 10/380,806 recorded at 014359/0812	NITROGEN DOPED SILICON SUBSTANTIALLY FREE OF OXIDATION INDUCED STACKING FAULTS
MEMC2905.9	1990	US2004-0069114-A1 1/15/2004	10380,806 7/30/2003	7,182,809 2/27/2007	MEMC Electronic Materials, Inc.	014359/0812	NITROGEN DOPED SILICON SUBSTANTIALLY FREE OF OXIDATION INDUCED STACKING FAULTS
MEMC2907.1	3830	US2003-0079673-A1 5/11/2003	10/28/1,632 10/28/2002	6,866,713 3/15/2005	MEMC Electronic Materials, Inc.	01356,20482	SEED CRYSTALS FOR PULLING SINGLE CRYSTAL SILICON
MEMC2960.1	5778	US2002-0100410-A1 8/11/2002	10/054,629 1/22/2002	6,946,539 1/25/2005	MEMC Electronic Materials, Inc.	012789/0747	LOW DEFECT DENSITY SILICON HAVING A VACANCY-DOMINATED CORE SUBSTANTIALLY FREE OF OXIDATION INDUCED STACKING FAULTS
MEMC2960.9	5113	US2005-0150445-A1 7/14/2005	11605,987 2/27/2004	7,217,320 5/15/2007	MEMC Electronic Materials, Inc.	Division of 10/054,629 recorded at 012789/0747	LOW DEFECT DENSITY SILICON HAVING A VACANCY-DOMINATED CORE SUBSTANTIALLY FREE OF OXIDATION INDUCED STACKING FAULTS
MEMC2970.1	4314	US2003-00619B6-A1 4/3/2003	10/256,759 9/27/2002	7,132,091 1/17/2006	MEMC Electronic Materials, Inc.	013576/0951	SINGLE CRYSTAL SILICON INGOT HAVING A HIGH ARSENIC CONCENTRATION
MEMC2984.10	3201	US2005-0255671-A1 1/17/2005	11/174,908 7/5/2005	7,071,080 7/4/2006	MEMC Electronic Materials, Inc.	Division of 10/177,444 recorded at 013131/0822	PROCESS FOR PRODUCING SILICON ON INSULATOR STRUCTURE HAVING INTRINSIC GROWTH BY ION IMPLANTATION
MEMC2984.2	5976	US2003-0008435-A1 1/9/2003	10/177,444 1/21/2002	6,930,375 8/16/2005	MEMC Electronic Materials, Inc.	013131/0822	SILICON ON INSULATOR STRUCTURE HAVING AN EPITAXIAL LAYER AND INTRINSIC GROWTH
MEMC2992	2873	US2003-0068958-A1 4/11/2003	10/982,677 10/4/2001	6,712,673 3/30/2004	MEMC Electronic Materials, Inc.	012338/0298	POLISHING APPARATUS, POLISHING HEAD AND METHOD
MEMC3004.10	2878	US2005-0048247-A1 3/3/2005	10/863,340 10/12/2004	7,201,800 4/10/2007	MEMC Electronic Materials, Inc.	Division of 10/663,340 recorded at 013923/0124	PROCESS FOR MAKING SILICON WAFERS WITH STABILIZED OXYGEN PRECIPITATE NUCLEATION CENTERS
MEMC3004.2	8328	US2004-0136961-A1 7/24/2003	10/328,481 2/23/2002	6,908,781 10/26/2004	MEMC Electronic Materials, Inc.	013923/0124	SILICON WAFERS WITH STABILIZED OXYGEN PRECIPITATE NUCLEATION CENTERS AND PROCESS FOR MAKING THE SAME
MEMC3005.3	1197	US2004-0118333-A1 6/24/2004	10/699,036 10/31/2003	7,125,450 10/24/2005	MEMC Electronic Materials, Inc.	2004/0118333	PROCESS FOR PREPARING SINGLE CRYSTAL SILICON USING CRUCIBLE ROTATION TO CONTROL TEMPERATURE GRADIENT
MEMC3007	2404	US2004-0255847-A1 1/22/2004	10465,528 6/19/2003	6,942,733 9/13/2005	MEMC Electronic Materials, Inc.	013911/0117	FLUID SEALING SYSTEM FOR A CRYSTAL PULLER
2844-107 (MEMC3011.1)	6422	US2003-0182469-A1 10/16/2003	10/27,660 10/22/2002	6,900,565 10/22/2002	MEMC Electronic Materials, Inc.	2003/0192469	PROCESS FOR CONTROLLING DENUDED ZONE DEPTH IN AN IDEAL OXYGEN PRECIPITATING SILICON WAFER
2844-138 (MEMC3035.1)	5409	US2004-0112277-A1 6/17/2004	10/705,813 1/11/2003	5,668,045 08/346,895	MEMC Electronic Materials, Inc.	2004/0112277	CRYSTAL PULLER AND METHOD FOR GROWING A MONOCRYSTALLINE INGOT
MEMC3043	3340			9/16/1997	MEMC Electronic Materials, Inc.	00732/00390	PROCESS FOR STRIPPING OUTER EDGE OF BESOI WAFERS